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Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32794 ... B32798

Date: October 2011

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MKP AC filtering

Typical applications

 Output AC filtering for power converters UPS, solar inverters, motor drives

Climatic

- Max. operating temperature: 105 °C
- Climatic category (IEC 60068-1): 40/85/56

Construction

- Dielectric: Polypropylene (PP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Optimized AC voltage performance
- High ripple current/frequency capability
- Small dimensions
- For PCB mounting

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 -1 mm
- Special lead lengths available on request

Marking

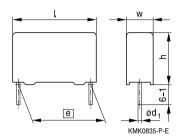
Manufacturer's logo, date code, rated capacitance (coded), capacitance tolerance (code letter), rated AC voltage

Delivery mode

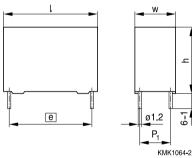
Bulk (untaped, lead length 6-1 mm)

Dimensional drawings

2-pin version



4-pin version



Dimensions in mm

Version	Lead spacing e ±0.4	Lead diameter d ₁	Туре
2-pin	27.5	0.8	B32794D
2-pin	37.5	1.0	B32796E/T
4-pin	37.5	1.2	B32796G
4-pin	52.5	1.2	B32798G





MKP AC filtering

Overview of available types

Lead spacing	27.5 mm						
Туре	B32794						
Page	6						
V _{RMS} (V AC)	250	300	350	400			
C _R (µF)							
0.82							
1.2							
1.5							
2.0							
2.2							
2.5							
3.3							
3.5							
4.0							
5.0							
6.3							
7.5							
8.0							
10							
12							
15							





Lead spacing	37.5 mm			
Туре	B32796			
Page	7			
V _{RMS} (V AC)	250	300	350	400
C _R (μF)				
2.7				
3.5				
4.0				
5.0				
5.6				
7.5				
8.0				
10				
11				
13				
14				
15				
16				
20				
22				
24				
25				
30				
34				
40				
45				





Landan and a	50 5 ·····							
Lead spacing								
Type	B32798	332798						
Page	9			_				
V _{RMS} (V AC)	250	300	350	400				
C _R (μF)								
18								
20								
25								
26								
30								
35								
40								
55								
75								





MKP AC filtering

Ordering codes and packing units (lead spacing 27.5 mm)

V_{RMS}	V_R	C _R	Max. dimensions	P ₁	Ordering code	I _{RMS}	ESL	ESR	Untaped
			$w \times h \times I$		(composition see	60 °C		10 kHz	·
					below)	10 kHz			pcs./
V AC	V DC	μF	mm	mm		Α	nΗ	mΩ	MOQ
250	630	2.5	$11.0 \times 19.0 \times 31.5$	_	B32794D2255+000	4	24	14.1	2352
		4.0	$11.0 \times 21.0 \times 31.5$	_	B32794D2405+000	6	25	9.1	2352
		6.3	$15.0\times24.5\times31.5$	_	B32794D2635+000	8	26	6.1	1680
		10	$16.0 \times 32.0 \times 31.5$	_	B32794D2106+000	11	27	4.2	1064
		15	$22.0\times36.5\times31.5$	_	B32794D2156+000	13	28	3.1	784
300	700	2.0	$11.0 \times 19.0 \times 31.5$	_	B32794D3205+000	4	24	15.6	2352
		3.3	$13.5\times23.0\times31.5$	_	B32794D3335+000	6	25	9.7	1932
		5.0	$14.0\times24.5\times31.5$	_	B32794D3505+000	7	26	6.7	1848
		8.0	$18.0\times33.0\times31.5$	_	B32794D3805+000	9	27	4.6	952
		12	$22.0\times36.5\times31.5$	_	B32794D3126+000	11	28	3.5	784
350	875	1.2	$11.0 \times 19.0 \times 31.5$	_	B32794D8125+000	3	24	21.2	2352
		2.2	$12.5 \times 21.5 \times 31.5$	_	B32794D8225+000	5	25	11.9	2100
		3.3	$15.0\times24.5\times31.5$	_	B32794D8335+000	7	26	8.2	1680
		5.0	$18.0\times33.0\times31.5$	_	B32794D8505+000	9	27	5.8	952
		7.5	$22.0\times36.5\times31.5$	-	B32794D8755+000	12	28	4.5	784
400	1050	0.82	$11.0 \times 19.0 \times 31.5$	_	B32794D4824+000	3	24	26.5	2352
		1.5	$13.5\times23.0\times31.5$	_	B32794D4155+000	4	25	14.8	1932
		2.2	$14.0\times24.5\times31.5$	_	B32794D4225+000	6	26	10.4	1848
		3.5	$18.0\times33.0\times31.5$	_	B32794D4355+000	8	27	6.9	952
-		5.0	$22.0\times36.5\times31.5$	_	B32794D4505+000	11	28	5.5	784

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$



MKP AC filtering



Ordering codes and packing units (lead spacing 37.5 mm)

$\overline{V_{RMS}}$	V_R	C _R	Max. dimensions	P₁	Ordering code	I _{RMS}	ESL	ESR	Untaped
			$w \times h \times I$	·	(composition see	60 °C		10 kHz	oapou
					below)	10 kHz			pcs./
V AC	V DC	μF	mm	mm	,	Α	nΗ	mΩ	MOQ
250	630	8	24.0 × 15.0 × 41.5	_	B32796T2805+000	8	21	9	1040
		11	$24.0 \times 19.0 \times 41.5$	_	B32796T2116+000	10	23	8	780
		22	$20.0 \times 39.5 \times 42.0$	10.2	B32796G2226+000	15	30	3.2	640
		22	$20.0 \times 39.5 \times 42.0$	_	B32796E2226+000	14	30	3.2	640
		25	$28.0 \times 37.0 \times 42.0$	10.2	B32796G2256+000	17	30	2.9	440
		25	$28.0 \times 37.0 \times 42.0$	_	B32796E2256+000	16	30	2.9	440
		40	$30.0 \times 45.0 \times 42.0$	20.3	B32796G2406+000	21	33	2.3	400
		40	$30.0 \times 45.0 \times 42.0$	_	B32796E2406+000	20	33	2.3	400
		45	$33.0\times48.0\times42.5$	20.3	B32796G2456+000	23	33	1.9	180
300	700	5.6	$24.0 \times 15.0 \times 41.5$	_	B32796T3565+000	7	21	12	1040
		7.5	$24.0 \times 19.0 \times 41.5$	_	B32796T3755+000	9	23	10	780
		16	$20.0\times39.5\times42.0$	10.2	B32796G3166+000	14	30	3.9	640
		16	$20.0 \times 39.5 \times 42.0$	_	B32796E3166+000	13	30	3.9	640
		20	$28.0 \times 37.0 \times 42.0$	10.2	B32796G3206+000	15	30	3.1	440
		20	$28.0 \times 37.0 \times 42.0$	_	B32796E3206+000	14	30	3.1	440
		30	$30.0 \times 45.0 \times 42.0$	20.3	B32796G3306+000	19	33	2.2	400
		30	$30.0 \times 45.0 \times 42.0$	_	B32796E3306+000	18	33	2.2	400
		34	$33.0 \times 48.0 \times 42.5$	20.3	B32796E3346+000	20	33	1.9	180
350	875	4	$24.0 \times 15.0 \times 41.5$	_	B32796T8405+000	7	21	13	1040
		5	$24.0 \times 19.0 \times 41.5$	_	B32796T8505+000	9	23	11	780
		10	$20.0\times39.5\times42.0$	10.2	B32796G8106+000	12	30	4.9	640
		10	$20.0\times39.5\times42.0$	_	B32796E8106+000	11	30	4.9	640
		14	$28.0 \times 37.0 \times 42.0$	10.2	B32796G8146+000	15	30	3.6	440
		14	$28.0 \times 37.0 \times 42.0$	_	B32796E8146+000	14	30	3.6	440
		15	$30.0\times45.0\times42.0$	20.3	B32796G8156+000	15	30	3.0	400
		20	$30.0 \times 45.0 \times 42.0$	20.3	B32796G8206+000	19	30	2.6	400
		20	$30.0\times45.0\times42.0$	_	B32796E8206+000	18	30	2.6	400
		24	$33.0\times48.0\times42.5$	20.3	B32796G8246+000	20	30	2.5	180

 $\mathsf{MOQ} = \mathsf{Minimum}$ Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





MKP AC filtering

Ordering codes and packing units (lead spacing 37.5 mm)

V_{RMS}	V_R	C _R	Max. dimensions	P ₁	Ordering code	I _{RMS}	ESL	ESR	Untaped
			$w \times h \times I$		(composition see	60 °C		10 kHz	
					below)	10 kHz			pcs./
V AC	V DC	μF	mm	mm		Α	nΗ	mΩ	MOQ
400	1050	2.7	$24.0 \times 15.0 \times 41.5$	_	B32796T4275+000	7	21	15	1040
		3.5	$24.0 \times 19.0 \times 41.5$	_	B32796T4355+000	8	23	13	780
		7.5	$20.0\times39.5\times42.0$	10.2	B32796G4755+000	11	30	5.5	640
		7.5	$20.0 \times 39.5 \times 42.0$	_	B32796E4755+000	10	30	5.5	640
		10	$28.0 \times 37.0 \times 42.0$	10.2	B32796G4106+000	14	30	4.5	440
		10	$28.0 \times 37.0 \times 42.0$	_	B32796E4106+000	13	30	4.5	440
		13	$30.0 \times 45.0 \times 42.0$	20.3	B32796G4136+000	17	33	3.5	400
		13	$30.0 \times 45.0 \times 42.0$	_	B32796E4136+000	16	33	3.5	400
		16	$33.0\times48.0\times42.5$	20.3	B32796G4166+000	18	33	3.5	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = +10%



MKP AC filtering



Ordering codes and packing units (lead spacing 52.5 mm)

V_{RMS}	V_R	C _R	Max. dimensions	P ₁	Ordering code	I _{RMS}	ESL	ESR	Untaped
			$w \times h \times I$		(composition see	60 °C		10 kHz	
					below)	10 kHz			pcs./
V AC	V DC	μF	mm	mm		Α	nΗ	mΩ	MOQ
250	630	55	$30.0\times45.0\times57.5$	20.3	B32798G2556+000	21	35	2.7	280
		75	$35.0 \times 50.0 \times 57.5$	20.3	B32798G2756+000	25	38	2.1	108
300	700	40	$30.0\times45.0\times57.5$	20.3	B32798G3406+000	19	35	3.2	280
		55	$35.0\times50.0\times57.5$	20.3	B32798G3556+000	24	38	2.5	108
350	875	26	$30.0\times45.0\times57.5$	20.3	B32798G8266+000	18	35	4.5	280
		30	$35.0 \times 50.0 \times 57.5$	20.3	B32798G8306+000	20	37	4.0	108
		35	$35.0 \times 50.0 \times 57.5$	20.3	B32798G8356+000	22	38	3.0	108
		40	$35.0 \times 50.0 \times 57.5$	20.3	B32798G8406K000	22	38	3.0	108
400	1050	18	$30.0\times45.0\times57.5$	20.3	B32798G4186+000	16	35	4.7	280
		20	$35.0 \times 50.0 \times 57.5$	20.3	B32798G4206+000	17	37	4.5	108
		25	$35.0\times50.0\times57.5$	20.3	B32798G4256+000	20	38	3.5	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





MKP AC filtering

Technical data

Reference standard:	IEC 61071	EN 61071	VDE 0560-120

Operating temperature range (case)	Max. operating temperature, T _{op,max} +105 °C
	Upper category temperature T _{max} +85 °C
	Lower category temperature T _{min} -40 °C
	Note: At T > 85 °C de-rating for
	V _{RMS} (V AC) should be 1.5%/°C
Capacitance drift in range	2% respect the value measured at reference conditions
(−40 °C, −85 °C)	
Insulation Resistance R _{ins}	30 000 s
given as time constant	
$\tau = C_R \cdot R_{ins}$, rel. humidity $\leq 65\%$	
(minimum as-delivered values)	
Test voltage between terminals	1.5 · V _R for 10 s
	1.65 · V _R for 2 s
DC test voltage terminal to case (10 s)	2 · V _{RMS} + 1000 V AC (min. 2000 V AC) at 50 Hz
Maximum permissible overvoltage for	1.3 · V _{RMS}
short operating periods (max 1 min/day)	
Maximum peak current (A)	$I_{P,max} = C_R \cdot \frac{dV}{dt}$
Damp heat test	56 days/40 °C/93% relative humidity
Limit values after damp heat test	Capacitance change ∆C/C ≤ 5%
	Dissipation factor change $\Delta \tan \delta \le 1.5 \cdot 10^{-3}$ (at 1 kHz)
	Insulation resistance R _{ins} ≥ 50% of minimum
	as-delivered values
Change of temperature	In accordance with IEC 60068-2-14 (Test Nb)
Reliability: Failure rate λ	300 fit
Contino life t	50 000 h ot V
Service life t _{SL}	> 60 000 h at V _{RMS} For conversion to other operating conditions, refer to
	, ,
	chapter "Reliability" on page 439 from Data Book 2009.
Failure criteria:	
Total failure	Short/open circuit
Failure due to	Capacitance change ΔC/C ≥ 10%
variation of	· ·
parameters	Dissipation factor change $\Delta \tan \delta > 4 \cdot \text{upper limit value}$
parameters	Insulation resistance R_{ins} < 1500 $M\Omega$
	(C _B ≤0.33μF)
	or time constant $\tau = C_R \cdot R_{ins}$ < 500 s ($C_R > 0.33 \mu F$)



MKP AC filtering



Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

Lead spacing	27.5 mm			37.5 mm			52.5 mm					
Туре	B32794			B32796			B32798					
V _{RMS} (V AC)	250	300	350	400	250	300	350	400	250	300	350	400
	dV/dt in V/μs											
	27	31	39	47	19	21	26	32	12	14	18	21

Notes: Please take all additional data not mentioned above from our Data Book 2009 **Mounting guidelines**

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

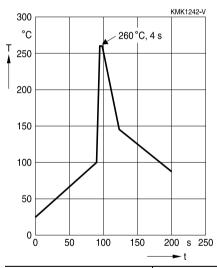
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series	Solder bath temperature	Soldering time





MKT	boxed (except 2.5 \times 6.5 \times 7.2 mm) coated	260 ±5 °C	10 ±1 s
	uncoated (lead spacing > 10 mm)		
MFP			
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤ 7.5 mm)		< 4 s
MKT	uncoated (lead spacing ≤ 10 mm)		recommended soldering
	insulated (B32559)		profile for MKT uncoated
			(lead spacing ≤ 10 mm) and
			insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 $\pm 0.5)$ mm thick, between capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors	
tan δ	As specified in sectional specification	



MKP AC filtering



1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering





MKP AC filtering

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences capacitors in finished	





MKP AC filtering

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	,
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



MKP

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
L _S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
2	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
λ _{test}	· · · · · · · · · · · · · · · · · · ·	· ·
P _{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R _i	Internal resistance	Innenwiderstand
Rins	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$\tan \delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
OL	and voltage	-spannung
Top	Operating temperature	Beriebstemperatur
T _{op}	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
	Reference service life	Referenz-Lebensdauer
t _{SL}		
V_{AC}	AC voltage	Wechselspannung





Symbol	English	German
V _C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{\circ}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
ν̂ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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